



Federal Communications Commission
7435 Oakland Mills Road
Columbia MD 21046

Subject: **Laird Connectivity LLC** and **SQG** Attestation Statement

Reference: a) FCC CFR section 2.911(d)(5)(i)
b) FCC Section 2.911(d)(5)(ii)
c) FCC Section 2.911(d)(7)

- a) **Laird Connectivity LLC** certifies that the equipment [FCC ID: **SQG-RM1262**] for which authorization is sought is not "covered" equipment prohibited from receiving an equipment authorization pursuant to section 2.903 of the FCC rules;
- b) **Laird Connectivity LLC** certifies that, as of the date of the filing of the application, the applicant **[is not]** identified on the Covered List (as a specifically named entity or any of its subsidiaries or affiliates) as an entity producing "covered" equipment;
- c) **Laird Connectivity LLC** as required by section 2.911(d)(7), will also serve as the agent for service of process for the above referenced FCC Grantee Code. The service of process includes, but is not limited to, delivery of any correspondence, notices, orders, decisions, and requirements of administrative, legal, or judicial process related to Commission proceedings. The applicant acknowledges that they will maintain an agent for service of process in the United States for no less than one year after either the grantee has permanently terminated all marketing and importation of the applicable equipment within the U.S., or the conclusion of any Commission-related administrative or judicial proceeding involving the equipment, whichever is later. The applicant further acknowledges their responsibility to inform the FCC whenever the following agent information changes.

Designated Agent

Company name: Laird Connectivity LLC
Grantee Code: SQG
Contact Name: Brian Petted, Technology Leader
Street Address: W66 N220 Commerce Court
City/Province/Zip: Cedarburg, Wisconsin, 53012
Telephone No: (262)-421-4974
Email: brian.petted@lairdconnect.com
FRN: 0022590616

Sincerely yours,

Signed by the Applicant



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Laird
CONNECTIVITY

Name: Brian Petted

Title: Technology Leader

Date: May 18, 2023